

EVVOSEMI[®]

THINK CHANGE DO



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

Product Specification

| | | |
|--------------|-------------|---------|
| ▶ Domestic | Part Number | IRF7832 |
| ▶ Overseas | Part Number | IRF7832 |
| ▶ Equivalent | Part Number | IRF7832 |

EV is the abbreviation of name EVVO

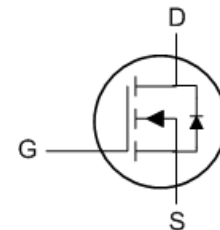
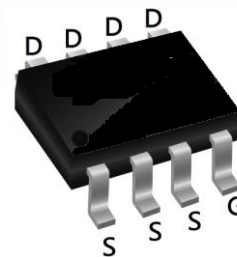
N-Ch 30V Fast Switching MOSFETs

- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary

| BVDSS | RDSON | ID |
|-------|-------|-----|
| 30V | 4mΩ | 15A |

SOP8 Pin Configuration



Description

The IRF7832 is the high cell density trenched N-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The IRF7832 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|--------------------------------|--|------------|------------------|
| V_{DS} | Drain-Source Voltage | 30 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D @ T_A = 25^\circ\text{C}$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 15 | A |
| $I_D @ T_A = 70^\circ\text{C}$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 12 | A |
| I_{DM} | Pulsed Drain Current ² | 75 | A |
| EAS | Single Pulse Avalanche Energy ³ | 144.7 | mJ |
| I_{AS} | Avalanche Current | 53.8 | A |
| $P_D @ T_A = 25^\circ\text{C}$ | Total Power Dissipation ⁴ | 1.5 | W |
| T_{STG} | Storage Temperature Range | -55 to 175 | $^\circ\text{C}$ |
| T_J | Operating Junction Temperature Range | -55 to 175 | $^\circ\text{C}$ |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|--|------|------|--------------------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient ¹ | --- | 85 | $^\circ\text{C/W}$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case ¹ | --- | 24 | $^\circ\text{C/W}$ |

N-Ch 30V Fast Switching MOSFETs

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|--|--|------|-------|-----------|---------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V$, $I_D=250\mu A$ | 30 | --- | --- | V |
| $\Delta BV_{DSS}/\Delta T_J$ | BV_{DSS} Temperature Coefficient | Reference to 25°C , $I_D=1mA$ | --- | 0.021 | --- | $V/^\circ\text{C}$ |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance ² | $V_{GS}=10V$, $I_D=15A$ | --- | --- | 4 | $m\Omega$ |
| | | $V_{GS}=4.5V$, $I_D=10A$ | --- | --- | 6 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}$, $I_D=250\mu A$ | 1.0 | --- | 2.5 | V |
| $\Delta V_{GS(th)}$ | $V_{GS(th)}$ Temperature Coefficient | | --- | -5.73 | --- | $mV/^\circ\text{C}$ |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=24V$, $V_{GS}=0V$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | μA |
| | | $V_{DS}=24V$, $V_{GS}=0V$, $T_J=55^\circ\text{C}$ | --- | --- | 5 | |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20V$, $V_{DS}=0V$ | --- | --- | ± 100 | nA |
| g_{fs} | Forward Transconductance | $V_{DS}=5V$, $I_D=15A$ | --- | 26.5 | --- | S |
| R_g | Gate Resistance | $V_{DS}=10V$, $V_{GS}=0V$, $f=1MHz$ | --- | 1.4 | --- | Ω |
| Q_g | Total Gate Charge (4.5V) | $V_{DS}=20V$, $V_{GS}=4.5V$, $I_D=12A$ | --- | 31.6 | | nC |
| Q_{gs} | Gate-Source Charge | | --- | 6.1 | | |
| Q_{gd} | Gate-Drain Charge | | --- | 13.8 | | |
| $T_{d(on)}$ | Turn-On Delay Time | $V_{DD}=15V$, $V_{GS}=10V$, $R_G=1.5\Omega$ $I_D=15A$ | --- | 11.2 | | ns |
| T_r | Rise Time | | --- | 49 | | |
| $T_{d(off)}$ | Turn-Off Delay Time | | --- | 35 | | |
| T_f | Fall Time | | --- | 7.8 | | |
| C_{iss} | Input Capacitance | $V_{DS}=15V$, $V_{GS}=0V$, $f=1MHz$ | --- | 3075 | | pF |
| C_{oss} | Output Capacitance | | --- | 400 | | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 315 | | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|--|---|------|------|------|------|
| I_S | Continuous Source Current ^{1,5} | $V_G=V_D=0V$, Force Current | --- | --- | 15 | A |
| I_{SM} | Pulsed Source Current ^{2,5} | | --- | --- | 75 | A |
| V_{SD} | Diode Forward Voltage ² | $V_{GS}=0V$, $I_S=1A$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | V |

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 20Z copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{DD}=25V$, $V_{GS}=10V$, $L=0.1mH$, $I_{AS}=53.8A$
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

N-Ch 30V Fast Switching MOSFETs

Typical Characteristics

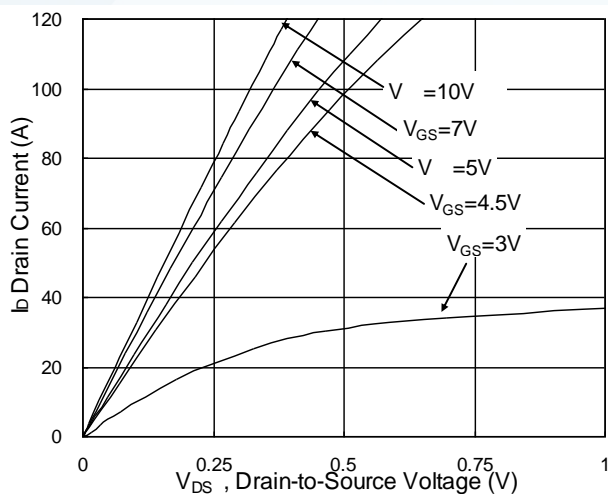


Fig.1 Typical Output Characteristics

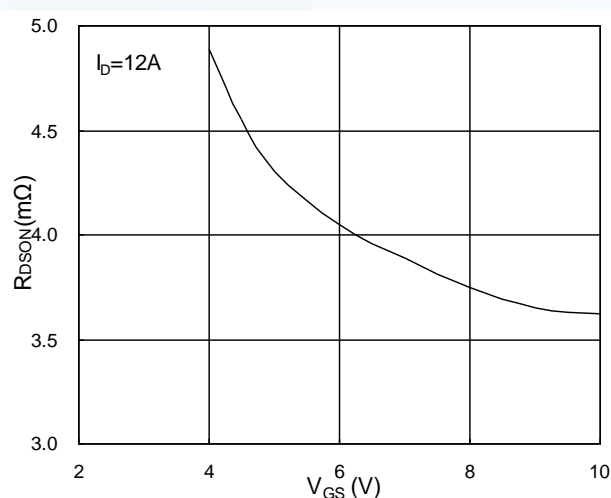


Fig.2 On-Resistance vs. G-S Voltage

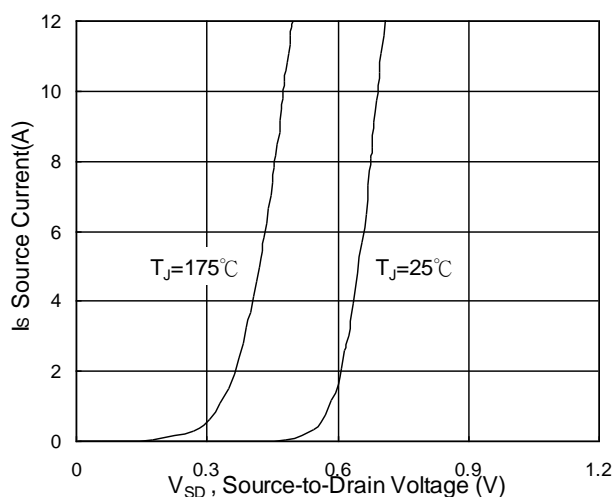


Fig.3 Forward Characteristics of Reverse

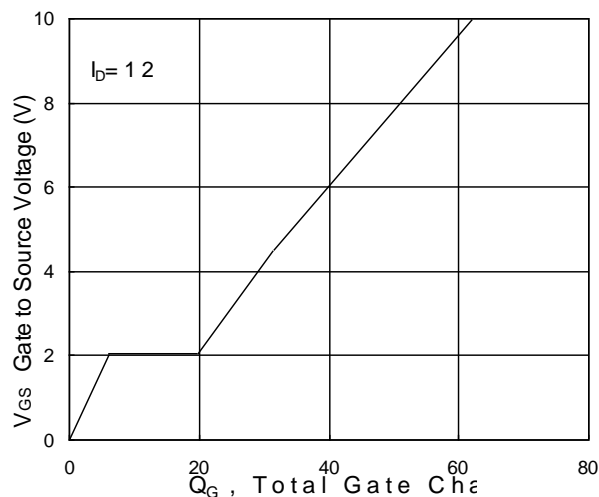


Fig.4 Gate-charge Characteristics

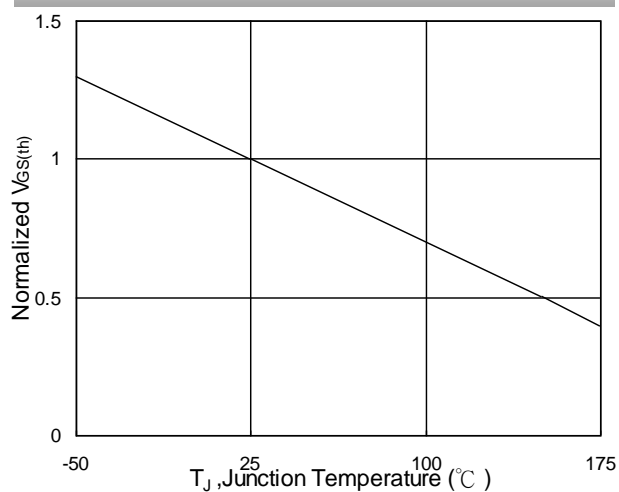


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

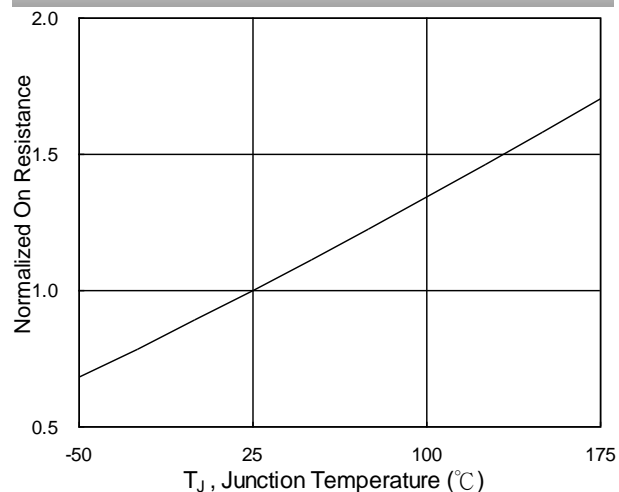


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

N-Ch 30V Fast Switching MOSFETs

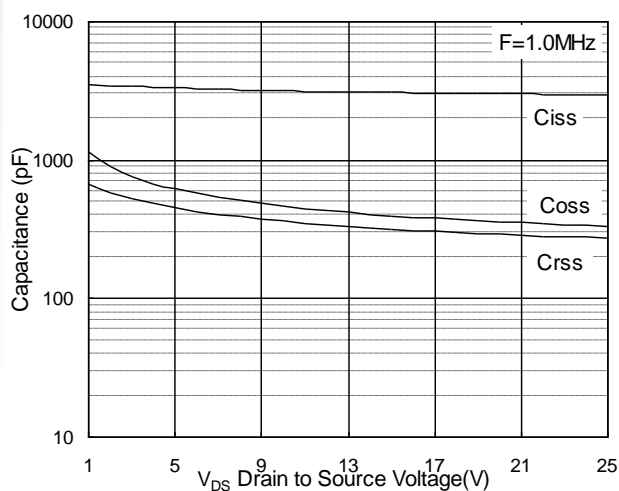


Fig.7 Capacitance

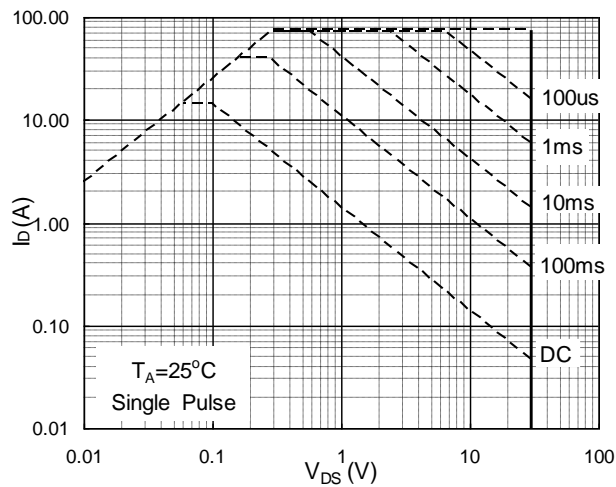


Fig.8 Safe Operating Area

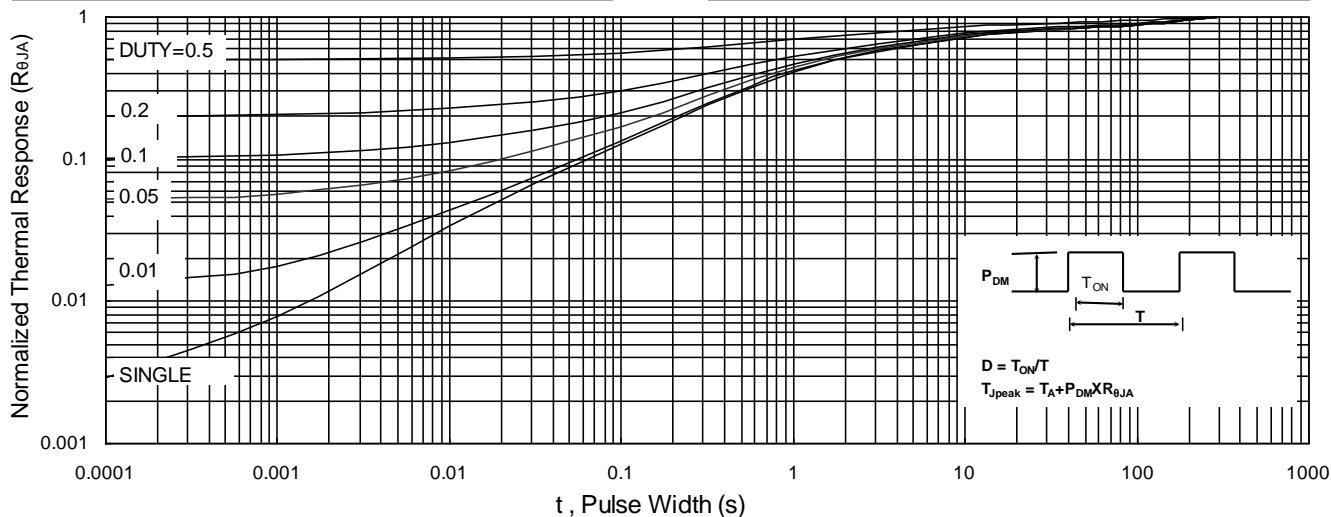


Fig.9 Normalized Maximum Transient Thermal Impedance

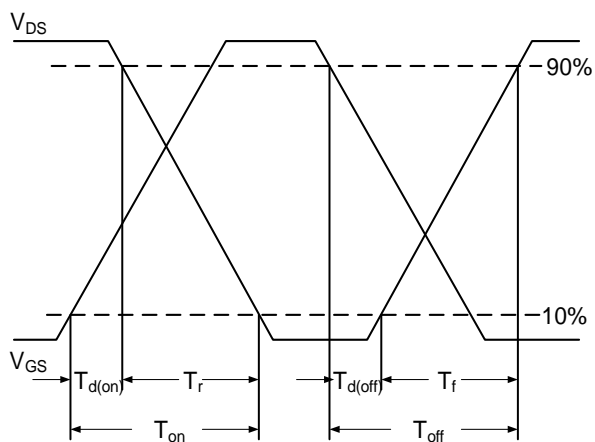


Fig.10 Switching Time Waveform

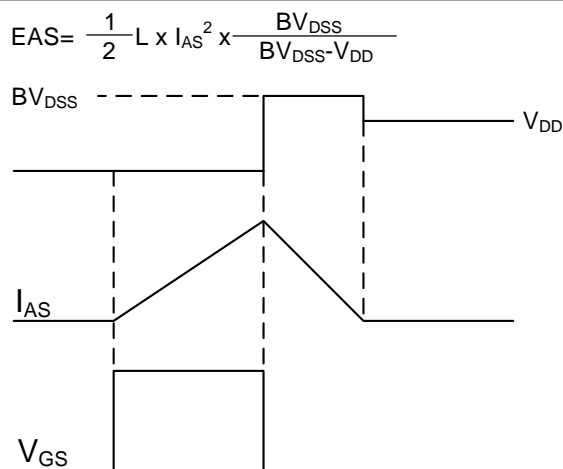


Fig.11 Unclamped Inductive Switching Waveform

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